Chip Ferrite Bead Part Numbering

(Part Number)	BL	Μ	18	AG	102	S	Ν	1	כ
	1	2	3	4	6	6	7	8	9

Product ID

B

Product ID			
BL	Chip Ferrite Beads		
• Туре			
Code	Туре		
А	Array Type		
E	DC Bias Characteristics Improved Type		
м	Ferrite Bead Single Type		
т	Assembly Type		
	·		

ODimensions (LxW)					
Code	Dimensions (LxW)	EIA			
02	0.4x0.2mm	01005			
03	0.6x0.3mm	0201			
15	1.0x0.5mm	0402			
18	1.6x0.8mm	0603			
2A	2.0x1.0mm	0804			
21	2.0x1.25mm	0805			
31	3.2x1.6mm	1206			
32	3.2x2.5mm	1210			
41	4.5x1.6mm	1806			
5B	5.0x5.0mm	2020			

Output Characteristics/Applications

Code *1	Characteristics/Applications	Series		
AG		BLM03/15/18/21, BLA2A/31		
AX	For General Use	BLM02/03/15		
TG		BLM18		
BA		BLM15/18		
BB		BLM02/03/15/18/21, BLA2A		
BC	For High-speed Signal Lines	BLM02/03/15		
BD		BLM03/15/18/21, BLA2A/31		
вх		BLM02/03/15		
KD		BLM15		
KG		BLM18		
KN		BLM31		
кх		BLM02KX		
PD		BLM15		
PG		BLM03/15/18/21/31/41		
PN	For Power Lines	BLE32		
PS		BLE18		
PX		BLM02/03/15		
PT		BLT		
SD				
SG		BLM18		
SN				
RK	For Digital Interface	BLM18/21		
HG	For GHz Band General Use	BLM03/15/18		
EB	For GHz Band High-speed Signal Lines (Low Direct Current Type)	BLM03		
EG		BLM15/18		
EX	For GHz Band General Use (Low DC Resistance Type)	BLM15		
HB		BLM03/15/18		
HD	For GHz Band High-speed Signal Lines	BLM03/15/18		
HE		BLM18		
НК	For GHz Band Digital Interface	BLM18		
GA	For High-GHz Band High-speed Signal Lines	BLM15		
GG	For High-GHz Band General Use	BLM15/18		

*¹ Frequency characteristics vary with each code.

Continued on the following page. earrow

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Impedance

Expressed by three figures. The unit is in ohm (Ω) at 100MHz. The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

6 Electrode

Expressed by a letter.

Ex.)	Code	Electrode
	S/F/T	Sn Plating
	А	Au Plating
	L	Lead Free Solder Plating

Category

Category	
Code	Category
Ν	For General

8Number of Circuits

Code	Number of Circuits	
1	1 Circuit	
4	4 Circuits	

Packaging

Code	Packaging	Series
к	Embossed Taping (ø330mm Reel)	BLE32, BLM21*1/31K/31P/41
L	Embossed Taping (ø180mm Reel)	BLE32, BLM02B/02K/21*1/31/41, BLT
В	Bulk	All Series *4
L	Paper Taping (ø330mm Reel)	BLE18, BLM03/15/18*3/21*2, BLA2A/31
D	Paper Taping (ø180mm Reel)	BLE18, BLM02/03/15/18/21* ² , BLA2A/31

*¹ BLM21BD222SN1/BLM21BD272SN1 only.

*² Except for BLM21BD222SN1/BLM21BD272SN1

*³ Except for BLM18T

*⁴ Except for BLM02BB

Chip EMIFIL[®] Part Numbering

(Part Number)	NF	Ζ	32	BW	3R6	Н	Ν	1	0	L
	1	2	3	4	6	6	7	8	9	10

Product ID

Product ID

NF	

2 Structure			
Code	Structure		
Z	Inductor Ty		

Inductor Type

Oimensions (LxW)

Code	Dimensions (LxW)	EIA
15	1.0x0.5mm	0402
18	1.6x0.8mm	0603
2M	2.0x1.6mm	0806
2H	2.5x2.0mm	1008
32	3.2x2.5mm	1210
5B	5.0x5.0mm	2020

4 Features

Code	Features	
SM	For Audio Lines Multilayer Type	
SW	For Audio Lines Wire Wound Type	
BW	For LED Lines Wire Wound Type	
BM	For LED Lines Multilayer Type	
SG	For Audio Lines Multilayer Type (For GHz Band Use)	

Impedance

Expressed by three figures. The unit is in ohm (Ω). The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

6 Inductance Tolerance

Code	Features	
s	For General Use (Sn Plating)	
н	For General Use (LF Solder) *1	
L	For General Use (LF Solder)	

*¹ NFZ32SW/32BW_H \Box 1 only.

Category

<u> </u>			
	Code	Category	
	Ν	For General	

Oumber of Circuits

Code	Number of Circuits	
1	1 Circuit	

Specification

Code	Specification	
0	Standard Type	
1	Low Rdc Type	

Packaging

Code	Packaging	Series
к	Embossed Taping (ø330mm Reel)	NFZ32/5B
L	Embossed Taping (ø180mm Reel)	NFZ2H/2M/32/5B
В	Bulk	NFZ15/18/2H/2M
D	Paper Taping (ø180mm Reel)	NFZ15/18

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